Electronic Patent Application Fee Transmittal								
Application Number:	10500196							
Filing Date:	10-Oct-2006							
Title of Invention:	Method and zone for sealing between two microstructure substrates							
First Named Inventor/Applicant Name:	Bernard Diem							
Filer:	Jasper W. Dockrey/Christine Pisarski							
Attorney Docket Number:	9905/23							
Filed as Large Entity								
U.S. National Stage under 35 USC 371 Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Claims in excess of 20		1615	2	52	104			
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			104